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FDT434P

P-Channel 2.5V Specified PowerTrench® MOSFET

General Description

This P-Channel 2.5V specified MOSFET is produced using ON Semiconductor's advanced PowerTrench process that has been especially tailored to minimize the on-state resistance and yet maintain low gate charge for superior switching performance.

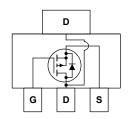
Applications

- Low Dropout Regulator
- DC/DC converter
- Load switch
- · Motor driving

Features

- -5.5 A, -20 V. $R_{DS(ON)}$ = 0.050 Ω @ V_{GS} = -4.5 V $R_{DS(ON)}$ = 0.070 Ω @ V_{GS} = -2.5 V.
- Low gate charge (13nC typical)
- High performance trench technology for extremely low $R_{\mbox{\scriptsize DS(ON)}}$.
- High power and current handling capability in a widely used surface mount package.





Absolute Maximum Ratings T_A=25°C unless otherwise noted

| Symbol | Parameter | | Ratings | Units | |
|-----------------------------------|--|------------|-------------|-------|--|
| V _{DSS} | Drain-Source Voltage | | -20 | V | |
| V _{GSS} | Gate-Source Voltage | | ±8 | V | |
| I _D | Drain Current - Continuous | (Note 1a) | -6 | Α | |
| | – Pulsed | | -30 | | |
| P _D | Power Dissipation for Single Operation | (Note 1a) | 3 | W | |
| | | (Note 1b) | 1.3 | | |
| | | (Note 1c) | 1.1 | | |
| T _J , T _{stg} | Operating and Storage Junction Tempera | ture Range | -55 to +150 | °C | |

Thermal Characteristics

| $R_{\theta JA}$ | Thermal Resistance, Junction-to-Ambient | (Note 1a) | 42 | °C/W |
|-----------------|---|-----------|----|------|
| $R_{\theta JC}$ | Thermal Resistance, Junction-to-Case | (Note 1) | 12 | °C/W |

Package Marking and Ordering Information

| - | Device Marking | Device | Reel Size | Tape width | Quantity |
|---|----------------|---------|-----------|------------|------------|
| Ī | 434 | FDT434P | 13" | 12mm | 2500 units |

| Symbol | Parameter | Test Conditions | Min | Тур | Max | Units |
|--|---|---|------|-------------------------|-------------------------|-------|
| Off Char | racteristics | | | ı | | |
| BV _{DSS} | Drain–Source Breakdown Voltage | $V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$ | -20 | | | V |
| ΔBV _{DSS} ΔT _J | Breakdown Voltage Temperature Coefficient | I_D = -250 μ A,Referenced to 25°C | | -28 | | mV/°C |
| I _{DSS} | Zero Gate Voltage Drain Current | $V_{DS} = -16 \text{ V}, V_{GS} = 0 \text{ V}$ | | | -1 | μΑ |
| I _{GSSF} | Gate–Body Leakage Current, Forward | V _{GS} = 8 V, V _{DS} = 0 V | | | 100 | nA |
| I_{GSSR} | Gate–Body Leakage Current, Reverse | V _{GS} = -8 V V _{DS} = 0 V | | | -100 | nA |
| On Char | acteristics (Note 2) | | | | | |
| $V_{GS(th)}$ | Gate Threshold Voltage | $V_{DS} = V_{GS}, I_{D} = -250 \mu A$ | -0.4 | -0.6 | -1 | V |
| $\frac{\Delta V_{GS(th)}}{\Delta T_J}$ | Gate Threshold Voltage Temperature Coefficient | I_D = -250 μ A,Referenced to 25°C | | 2 | | mV/°C |
| R _{DS(on)} | Static Drain–Source On–Resistance | V _{GS} = -4.5 V, I _D = -6 A V _{GS} = -2.5 V, I _D = -4 A V _{GS} = -4.5 V, I _D = -6 A T _J =125°C | | 0.040 0.050 0.067 | 0.050 0.070 0.083 | Ω |
| I _{D(on)} | On–State Drain Current | $V_{GS} = -4.5 \text{ V}, I_D = -6 \text{ A T}_J = 125^{\circ}\text{C}$ $V_{GS} = -4.5 \text{ V}, V_{DS} = -5 \text{ V}$ | -20 | | | Α |
| g FS | Forward Transconductance | $V_{DS} = -10 \text{ V}, \qquad I_{D} = -6 \text{ A}$ | | 6.5 | | S |
| Dynamic | Characteristics | | | | | |
| C _{iss} | Input Capacitance | $V_{DS} = -10 \text{ V}, \qquad V_{GS} = 0 \text{ V},$ | | 1187 | | pF |
| Coss | Output Capacitance | f = 1.0 MHz | | 270 | | pF |
| C _{rss} | Reverse Transfer Capacitance | 1 | | 114 | | pF |
| Switchin | ng Characteristics (Note 2) | | | | | |
| t _{d(on)} | Turn-On Delay Time | $V_{DD} = -5 \text{ V}, \qquad I_{D} = -1 \text{ A},$ | | 8 | 16 | ns |
| t _r | Turn-On Rise Time | $V_{GS} = -4.5 \text{ V}, R_{GEN} = 6 \Omega$ | | 15 | 25 | ns |
| $t_{\text{d(off)}}$ | Turn-Off Delay Time | 1 | | 45 | 65 | ns |
| t _f | Turn-Off Fall Time | 7 | | 30 | 50 | ns |
| Qg | Total Gate Charge | $V_{DS} = -10 \text{ V}, \qquad I_{D} = -6 \text{ A},$ | | 13 | 19 | nC |
| Q _{gs} | Gate-Source Charge | $V_{GS} = -4.5 \text{ V}$ | | 1.8 | | nC |
| Q _{gd} | Gate-Drain Charge | | | 3 | | nC |
| Drain-S | ource Diode Characteristics | and Maximum Ratings | | | | |
| Is | Maximum Continuous Drain–Source | | | | -2.5 | Α |
| V _{SD} | Drain–Source Diode Forward Voltage | $V_{GS} = 0 \text{ V}, I_{S} = -2.5 \text{ A} \text{(Note 2)}$ | | -0.75 | -1.2 | V |

^{1.} R_{BJA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. $\rm R_{\theta JC}$ is guaranteed by design while $\rm R_{\theta CA}$ is determined by the user's board design.



a) 42°C/W when mounted on a 1in² pad of 2 oz copper



b) 95°/W when mounted on a .0066 in² pad of 2 oz copper

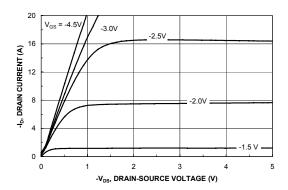


c) 110°/W when mounted on a minimum pad.

Scale 1:1 on letter size paper

2. Pulse Test: Pulse Width < 300μ s, Duty Cycle < 2.0%

Typical Characteristics



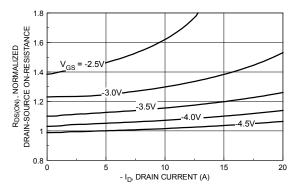
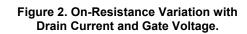
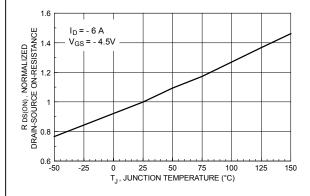


Figure 1. On-Region Characteristics.





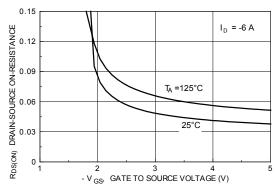
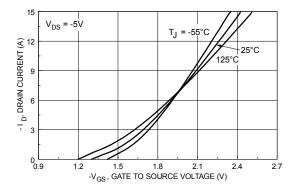


Figure 3. On-Resistance Variation withTemperature.

Figure 4. On-Resistance Variation with Gate-to-Source Voltage.



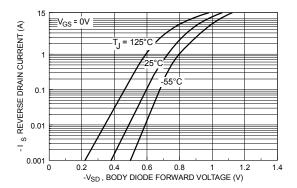
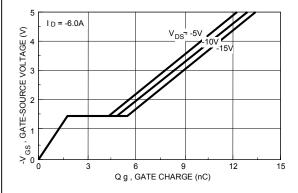


Figure 5. Transfer Characteristics.

Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature.

Typical Characteristics



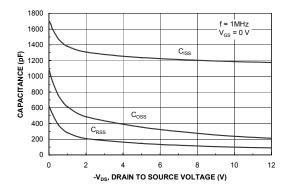


Figure 7. Gate Charge Characteristics.

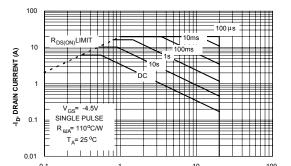


Figure 8. Capacitance Characteristics.

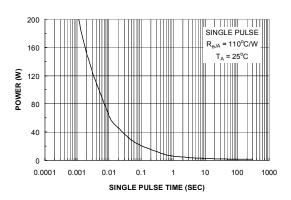


Figure 9. Maximum Safe Operating Area.

-V DS DRAIN-SOURCE VOLTAGE (V)



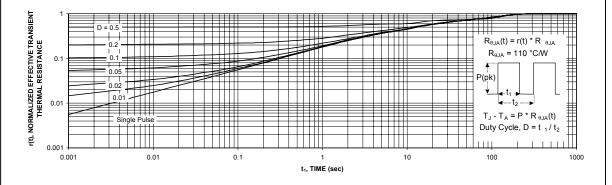


Figure 11. Transient Thermal Response Curve.

Thermal characterization performed using the conditions described in Note 1c. Transient thermal response will change depending on the circuit board design.

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